DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

FOR ITS M.	ANUFACTURE			
the specification of	f which is attached hereto un	less the following is che	cked	
was filed on _	as United States Applic	ation Number or was fil	ed on OCTOBER 7, 2004	as PCT
International Appl	lication Number PCT/JP200	4/015189 and was amer	nded on (if applicable)	ı .
	I have reviewed and understa ed by any amendment referro		bove-identified specification,	including the
I acknowledge the Regulations, § 1.56		which is material to pat	entability as defined in Title 2	37, Code of Federal
for patent or invent	tor's certificate listed below	and have also identified	ode, § 119 (a) – (d) of any for below any foreign application for which priority is claimed.	
miventor's certifica	the having a fifting date before	that of the application	for which priority is claimed.	Priority Claimed
(List prior foreign applications. See	356519/2003	JAPAN	16/10/2003	⊠ Yes □ No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	
		,		☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
•	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
(See note B)	•	additional prior foreign	•	
insofar as the subjection in the manner provinformation which	ect matter of each of the clair vided by the first paragraph of is material to patentability a	ns of this application is of Title 35, United State is defined in Title 37, C	Fany United States application not disclosed in the prior Units Code, § 112, I acknowledgeded of Federal Regulations, national or PCT internations	ted States application e the duty to disclose § 1.56 which became
арричано			Stat	us
(List prior U.S. Applications)	Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned
	Application Serial No.)	(Filing Date)	Patented Pend	ling
	Application Serial No.)	(Filing Date)	Patented Pend	ling

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850

Please direct all communications to the following address:

23850 PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, ' 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of fourth inventor (given name, family name)				
Inventor's signature	(8	Date		
Residence		Citizenship		
Post Office Address				
Eull name of fifth inv	enter (given name, family name)			
	emor (given name, family name)	Date		
Residence		Citizenship		
Post Office Address				
	Inventor's signature Residence Post Office Address Full name of second i Inventor's signature Residence Post Office Address Full name of third inv Inventor's signature Residence Post Office Address Full name of fourth in Inventor's signature Residence Post Office Address Full name of fourth in Inventor's signature Residence Post Office Address Full name of fifth inv Inventor's signature Residence Residence	Residence Post Office Address C/o Electronics Materials Plant, Kunisum SUMITOMO METAL MINING CO. 351-1, Kunitomi, Kyowa-cho, Iwanai-Full name of second inventor (given name, family name) T. Kakuta Hokkaido, Japan C/o Electronics Materials Plant, Kunisum SUMITOMO METAL MINING CO. 351-1, Kunitomi, Kyowa-cho, Iwanai-Full name of third inventor (given name, family name) Inventor's signature Residence Post Office Address Full name of fourth inventor (given name, family name) Inventor's signature Residence Post Office Address Full name of fifth inventor (given name, family name) Inventor's signature Residence Post Office Address		

NOTES

- A. Please list all foreign applications relating to the invention and check block, "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.